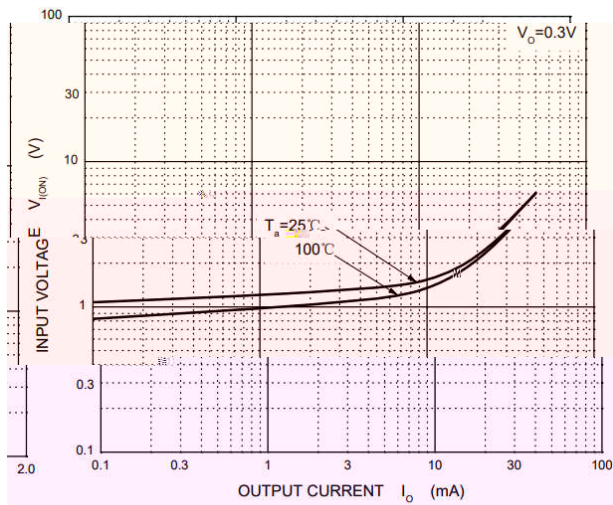
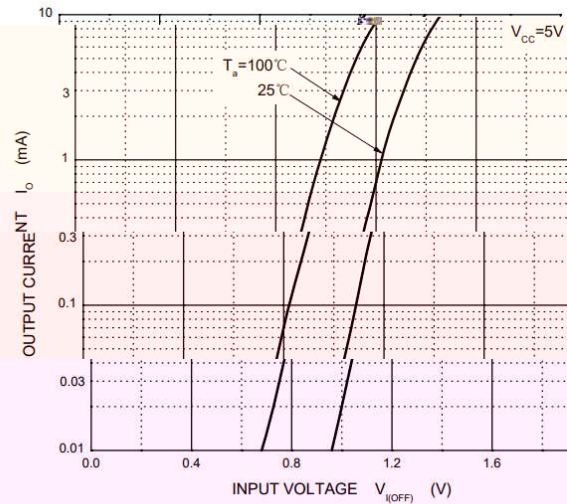


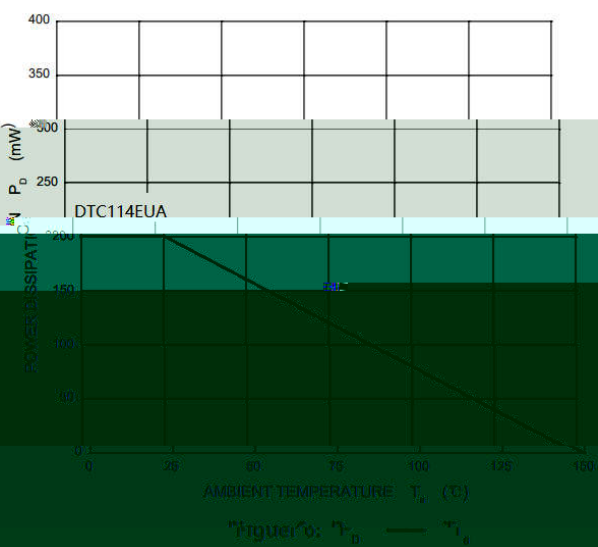
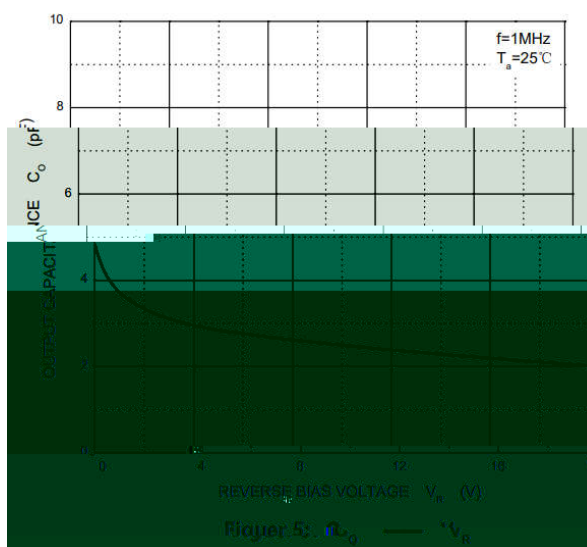
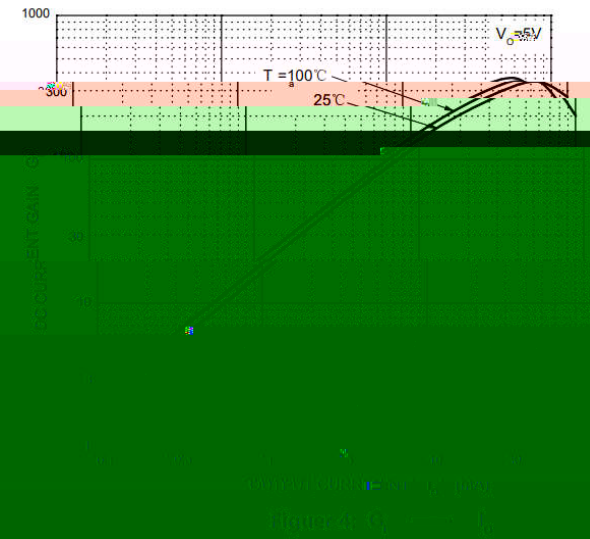
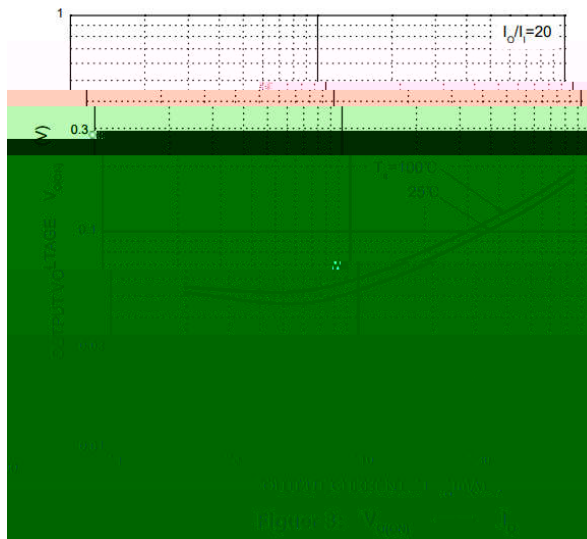
/ Electrical Characteristic Curve

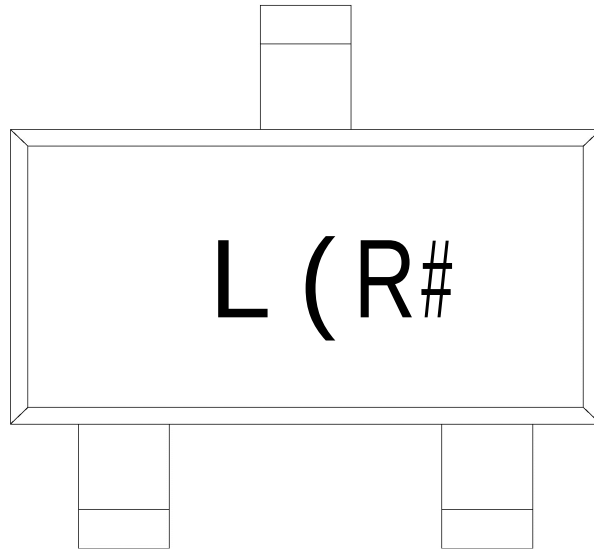


Figuer 1: ON Characteristics



Figuer 2: OFF Characteristics



/ **Marking Instructions**

H

(R

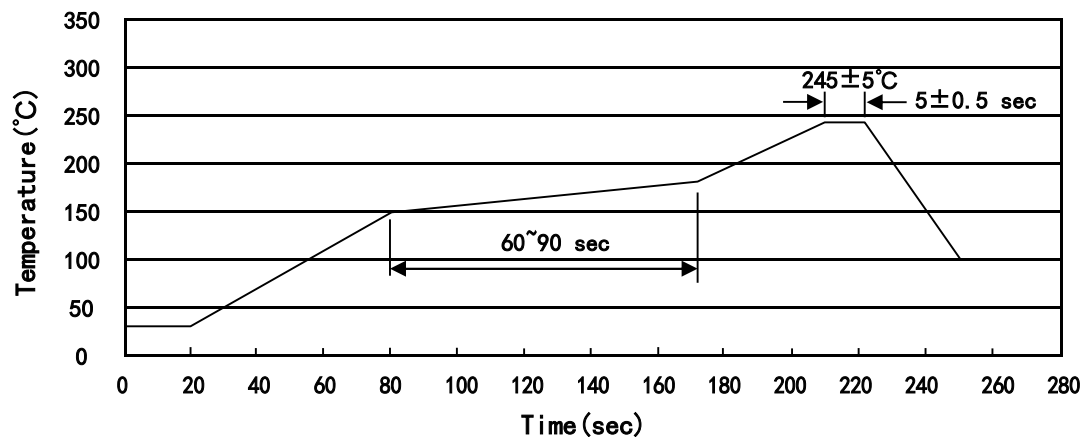
> . & 4#

H # # P. : 3D1I#P.J #

(R ?9.JG%&#<I3 #P.J #

#

() / Temperature Profile for IR Reflow Soldering(Pb-Free)



>. & 4#

N N*) NZ) `) a)7 %b# # # N! ?9 2 D&@1C4N\*)cNZ) H#<@ : 4`)ca)7 %!#
((R*±* *±)!*7 %b# # (!? DE#< : 3!4(R*±* H#BG9D&@.14*±)!*7 %!#
= (N) 57 %!# # # # =! P..A@1C#;3 J4#(cN) 57 %!#
#

#

/ Resistance to Soldering Heat Test Conditions

(`) $\pm^*$  # # N) $\pm$ N#7 %!# # # # < : 3!4(`)d*°C# # <@ : 4N)dN#7 %#

#

/ Packaging SPEC.

5## " "e#

?D%EDC #<13 # 封装形式#	S1#7 包装数量#					B: 17.1# 包装尺寸##-G1: : : 0#		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
: \$<=(=# =H)))#	N)#	=H)))#	`#	(NZH)))#	1" fZ#	(NZ) fN() fNZ)#	=a) f=Z* f ()*#	

#

/ Notices

#